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[Diodes Incorporated](#)

[ZLLS1000TA](#)

For any questions, you can email us directly:

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A Product Line of
Diodes Incorporated



ZLLS1000

40V HIGH CURRENT LOW LEAKAGE SCHOTTKY DIODE

Features

- Low Equivalent on Resistance
- Extremely Low Leakage (typically 6µA @30V)
- High current capability ($I_F = 1.16A$)
- Low V_F , Fast Switching Schottky
- SOT23 Package
- ZLLS1000 Complements Low Temperature Equivalent ZHCS1000
- Package Thermally Rated to +150°C
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: SOT23
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish
- Weight: 0.008 grams (Approximate)

Applications

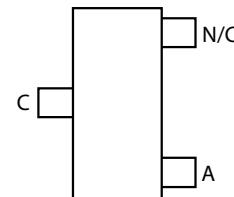
- DC – DC Converters
- Strobes
- Mobile Phones
- Charging Circuits
- Motor Control



Top View



Device Symbol



Pinout – Top View

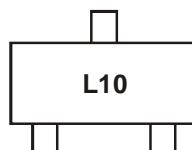
Ordering Information

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZLLS1000TA	L10	7	8	3,000 units
ZLLS1000TC	L10	13	8	10,000 units

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See <http://www.diodes.com> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Marking Information



L10 = Product type Marking Code

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

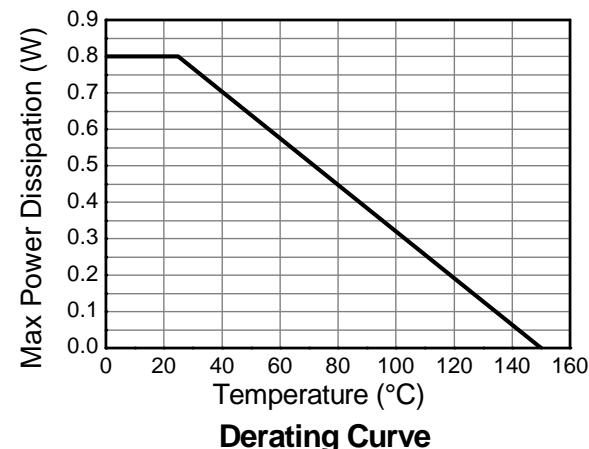
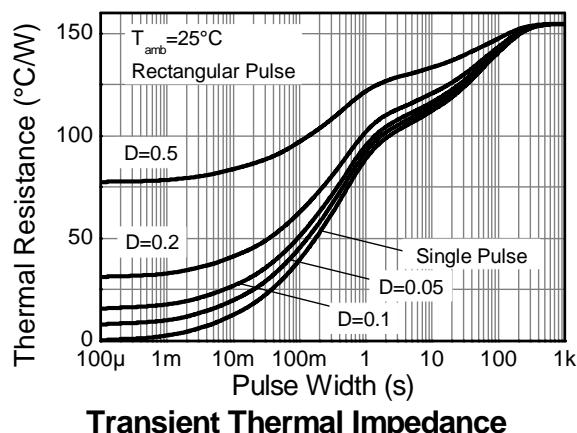
Characteristic	Symbol	Value	Unit
Continuous Reverse Voltage	V_R	40	V
Forward Current	I_F	1.16	A
Peak Repetitive Forward Current Rectangular Pulse Duty Cycle 50% 100 μs pulse width	I_{FPK}	2.6	A
Non Repetitive Forward Current $t \leq 100\mu\text{s}$ $t \leq 10\text{ms}$	I_{FSM}	22 6.4	A A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation @ $T_A = +25^\circ\text{C}$ Single Die Continuous Single Die Measured at $t < 5$ secs	P_D	0.8 1.18	W
Thermal Resistance Junction to Ambient (Note 4)	$R_{\theta JA}$	155	°C/W
Thermal Resistance Junction to Ambient (Note 5)	$R_{\theta JA}$	106	°C/W
Thermal Resistance Junction to Lead (Solder Point)	$R_{\theta JL}$	80	°C/W
Storage temperature range	T_{STG}	-55 to +150	°C
Junction temperature	T_J	150	°C

Notes: 4. For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.
5. For a device mounted on FRB PCB measured at $t < 5$ secs.

Thermal Characteristics and Derating information





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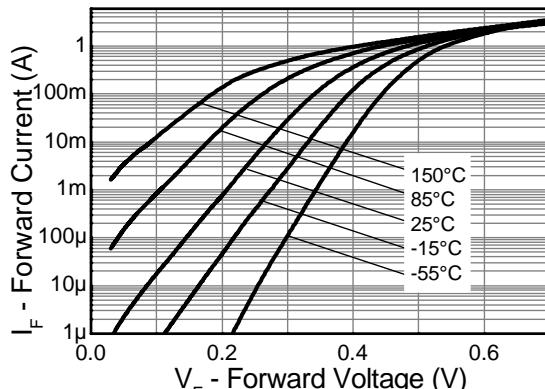


ZLLS1000

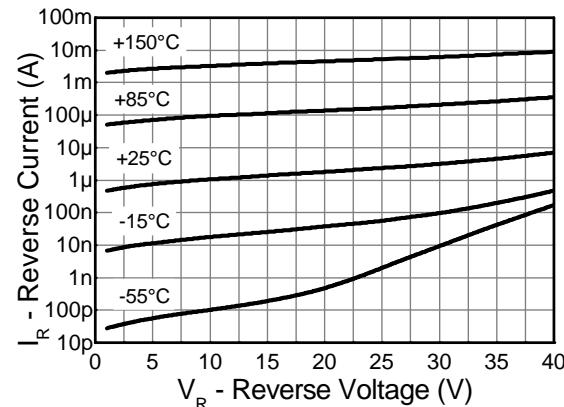
Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition	
Reverse breakdown voltage	$V_{(BR)R}$	40	-	-	V	$I_R = 500\mu\text{A}$	
Forward voltage (Note 6)		V_F	320	355	mV	$I_F = 50\text{mA}$	
			335	380		$I_F = 100\text{mA}$	
			380	425		$I_F = 250\text{mA}$	
			410	460		$I_F = 500\text{mA}$	
			440	510		$I_F = 750\text{mA}$	
			470	560		$I_F = 1\text{A}$	
			530	660		$I_F = 1.5\text{A}$	
			430	-		$I_F = 1000\text{mA}, T_A = +100^\circ\text{C}$	
Reverse current	I_R	-	5 500	20 -	μA μA	$V_R = 30\text{V}$ $V_R = 30\text{V}, T_A = +85^\circ\text{C}$	
Diode capacitance	C_D	-	28	-	pF	$f = 1\text{MHz}, V_R = 30\text{V}$	
Reverse recovery time Reverse recovery charge	t_{rr} Q_{rr}	-	5 350	-	ns nC	Switched from $I_F = 500\text{mA}$ to $V_R = 5.5\text{V}$ Measured @ $I_R 50\text{mA}$. $di/dt = 500\text{mA}/\text{ns}$. $R_{source} = 6\Omega$; $R_{load} = 10\Omega$	

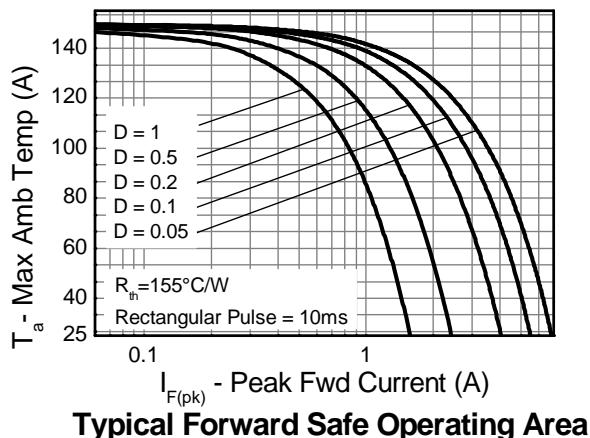
Notes: 6. Measured under pulsed conditions. Pulse width = 300 μs . Duty cycle < 2%



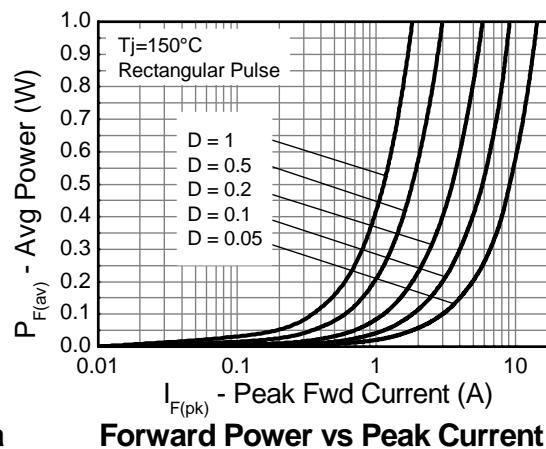
Typical Forward Characteristics



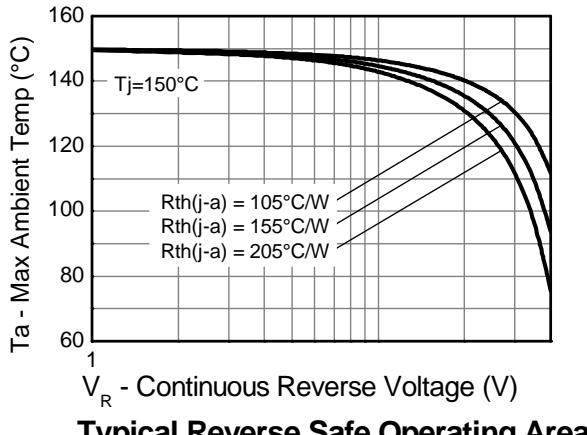
Typical Reverse Characteristics



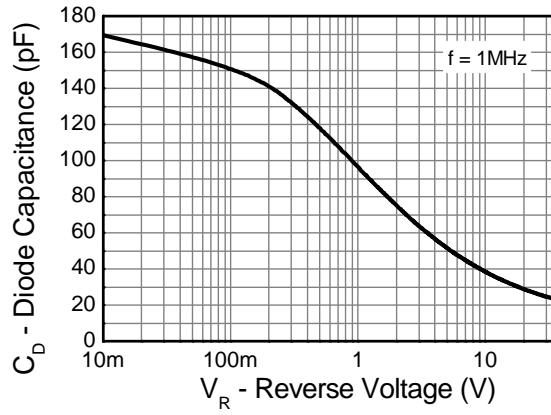
Typical Forward Safe Operating Area



Forward Power vs Peak Current

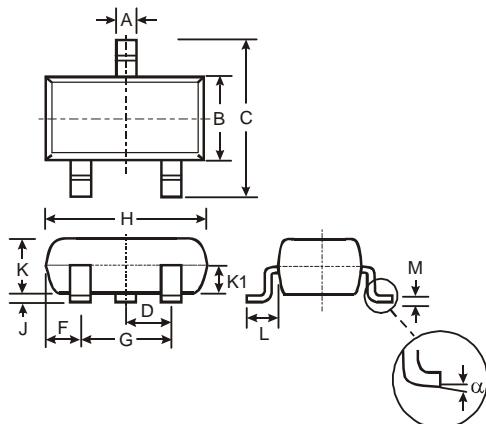


Typical Reverse Safe Operating Area



Capacitance vs Reverse Voltage

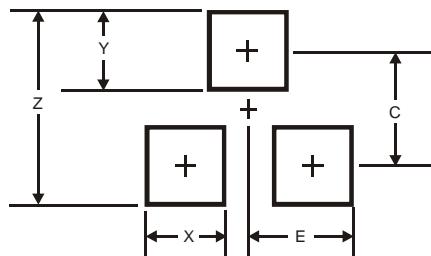
Package Outline Dimensions



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.903	1.10	1.00
K1	-	-	0.400
L	0.45	0.61	0.55
M	0.085	0.18	0.11
alpha	0°	8°	-

All Dimensions in mm

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

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